**Preferred Device** 

# NPN Silicon Expitaxial Transistor

This family of NPN Silicon Epitaxial transistors is designed for use as a general purpose amplifier and in switching applications. The device is housed in the SOT-223 package which is designed for medium power surface mount applications.

#### **Features**

- High Voltage: V<sub>(BR)CEO</sub> of 250 and 350 V
- The SOT-223 Package can be Soldered Using Wave or Reflow
- SOT-223 Package Ensures Level Mounting, Resulting in Improved Thermal Conduction, and Allows Visual Inspection of Soldered Joints
- The Formed Leads Absorb Thermal Stress During Soldering, Eliminating the Possibility of Damage to the Die
- PNP Complement is BSP16T1
- Moisture Sensitivity Level (MSL): 1
- ESD: Human Body Model (HBM) = 4 KV
   Machine Model (MM) = 400 V
- Pb-Free Package is Available

## **MAXIMUM RATINGS** (T<sub>C</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage (Open Base)	V <sub>CEO</sub>	350	Vdc
Collector-Base Voltage (Open Emitter)	V <sub>CBO</sub>	400	Vdc
Emitter-Base Voltage (Open Collector)	V <sub>EBO</sub>	5.0	Vdc
Collector Current (DC)	I <sub>C</sub>	100	mAdc

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Power Dissipation @ T <sub>A</sub> = 25°C (Note 1)	P <sub>D</sub>	0.8	W
Derate above 25°C		6.4	mW/°C
Thermal Resistance, Junction- to- Ambient	$R_{\theta JA}$	156	°C/W
Junction and Storage Temperature Range	T <sub>stg</sub>	- 65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

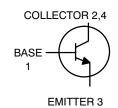
 Device mounted on a FR-4 glass epoxy printed circuit board using minimum recommended footprint.



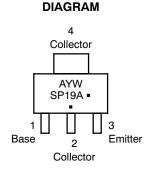
## ON Semiconductor®

http://onsemi.com

## SOT- 223 PACKAGE NPN SILICON HIGH VOLTAGE TRANSISTOR SURFACE MOUNT







**MARKING** 

A = Assembly Location

= Year

W = Work Week

SP19A = Specific Device Code = Pb-Free Package

(Note: Microdot may be in either location)

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
BSP19AT1	SOT-223	1000 / Tape & Reel
BSP19AT1G	SOT-223 (Pb-Free)	1000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristics	Symbol	Min	Max	Unit
OFF CHARACTERISTICS		•	•	•
Collector-Emitter Breakdown Voltage $(I_C = 1.0 \text{ mAdc}, I_B = 0)$	V <sub>(BR)CEO</sub>	350	-	Vdc
Collector-Base Cutoff Current (V <sub>CB</sub> = 400 Vdc, I <sub>E</sub> = 0)	Ісво	-	20	nAdc
Emitter-Base Cutoff Current (V <sub>EB</sub> = 5.0 Vdc, I <sub>C</sub> = 0)	I <sub>EBO</sub>	-	10	μAdc
ON CHARACTERISTICS (Note 2)				
DC Current Gain (I <sub>C</sub> = 20 mAdc, V <sub>CE</sub> = 10 Vdc)	h <sub>FE</sub>	40	-	-
Current-Gain — Bandwidth Product ( $I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 5.0 \text{ MHz}$ )	f <sub>T</sub>	70	-	MHz
Collector-Emitter Saturation Voltage ( $I_C = 50 \text{ mAdc}$ , $I_B = 4.0 \text{ mAdc}$ )	V <sub>CE(sat)</sub>	-	0.5	Vdc
Base-Emitter Saturation Voltage ( $I_C = 50 \text{ mAdc}$ , $I_B = 4.0 \text{ mAdc}$ )	V <sub>BE(sat)</sub>	-	1.3	Vdc

<sup>2.</sup> Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle = 2.0%

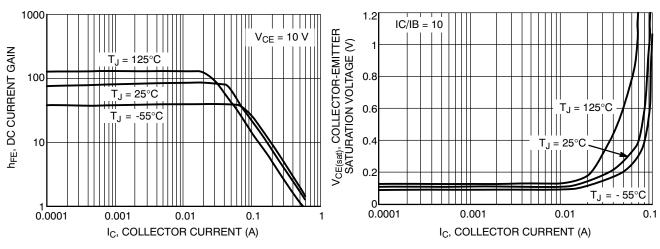


Figure 1. DC Current Gain

Figure 2. Collector Saturation Voltage

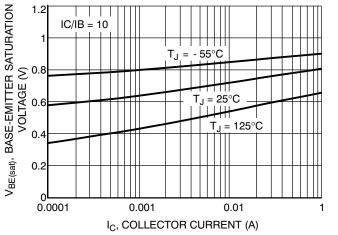


Figure 3. Base Saturation Voltage

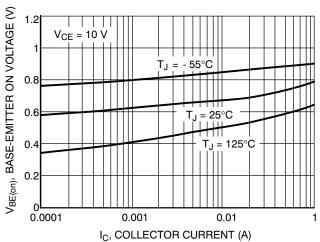


Figure 4. Base ON Voltage

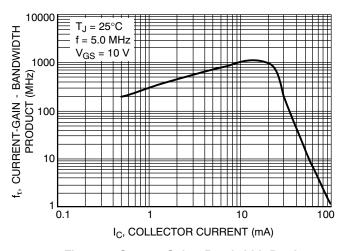


Figure 5. Current Gain - Bandwidth Product

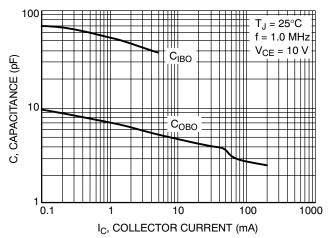
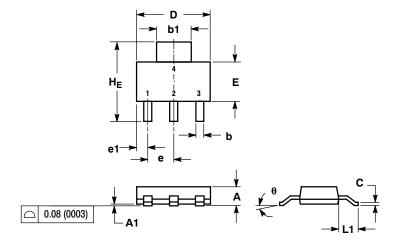


Figure 6. Capacitance

### PACKAGE DIMENSIONS

## SOT-223 (TO-261) CASE 318E-04 ISSUE L

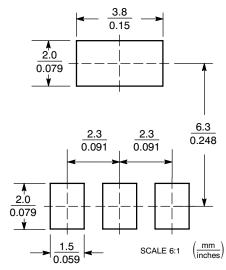


- 1. DIMENSIONING AND TOLERANCING PER ANSI
- 2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.50	1.63	1.75	0.060	0.064	0.068
A1	0.02	0.06	0.10	0.001	0.002	0.004
b	0.60	0.75	0.89	0.024	0.030	0.035
b1	2.90	3.06	3.20	0.115	0.121	0.126
С	0.24	0.29	0.35	0.009	0.012	0.014
D	6.30	6.50	6.70	0.249	0.256	0.263
E	3.30	3.50	3.70	0.130	0.138	0.145
е	2.20	2.30	2.40	0.087	0.091	0.094
e1	0.85	0.94	1.05	0.033	0.037	0.041
L1	1.50	1.75	2.00	0.060	0.069	0.078
HE	6.70	7.00	7.30	0.264	0.276	0.287
θ	0°	-	10°	0°	-	10°

STYLE 1:

- PIN 1. BASE
  2. COLLECTOR
  3. EMITTER
  4. COLLECTOR
- **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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